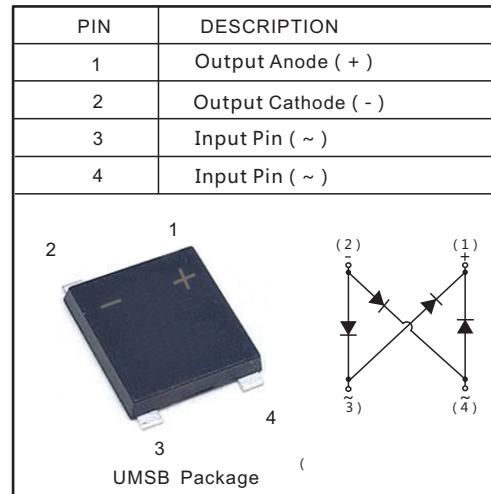


3A SURFACE MOUNT GLASS PASSIVATED BRIDGE RECTIFIER
FEATURES:

- Glass Passivated Chip Junction
- Reverse Voltage - 100 to 1000 V
- Forward Current - 3.0 A
- High Surge Current Capability
- Designed for Surface Mount Application

MECHANICAL DATA

- Case: UMSB
- Terminals: Solderable per MIL-STD-750, Method 2026

PINNING

Maximum Ratings and Electrical characteristics

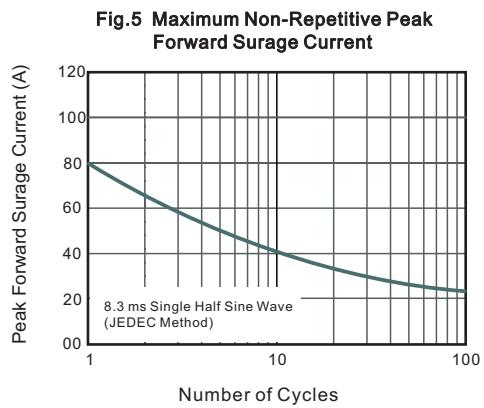
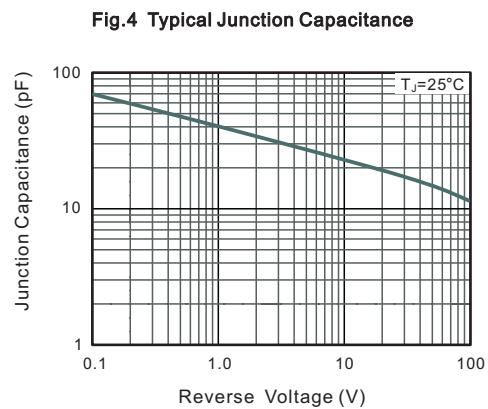
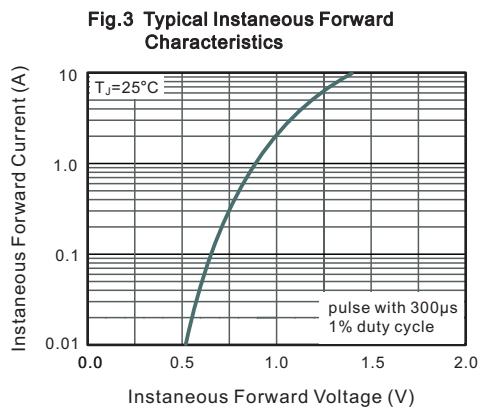
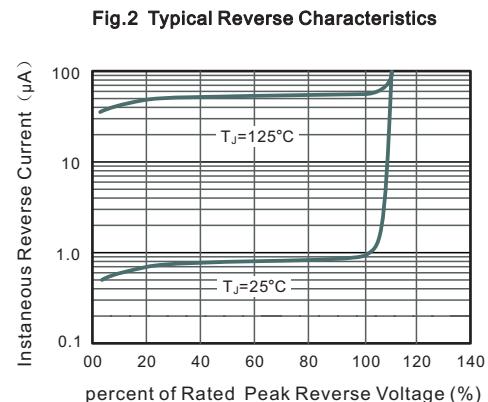
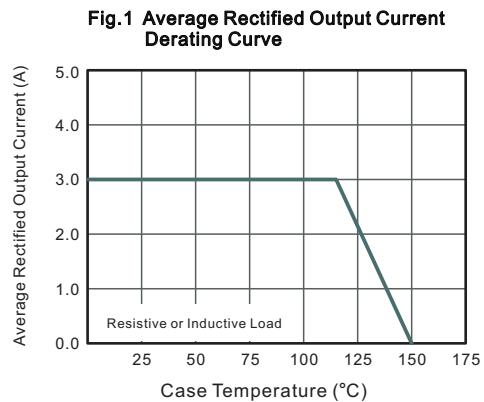
Ratings at 25 °C ambient temperature unless otherwise specified.

Single phase half-wave 60 Hz, resistive or inductive load, for capacitive load current derate by 20 %.

Parameter	Symbols	MSB30B	MSB30D	MSB30G	MSB30J	MSB30K	MSB30M	Units
Maximum Repetitive Peak Reverse Voltage	V_{RRM}	100	200	400	600	800	1000	V
Maximum RMS voltage	V_{RMS}	70	140	280	420	560	700	V
Maximum DC Blocking Voltage	V_{DC}	100	200	400	600	800	1000	V
Average Rectified Output Current	I_o	3.0						A
Peak Forward Surge Current 8.3 ms Single Half Sine Wave Superimposed on Rated Load (JEDEC Method)	I_{FSM}	80						A
Maximum Forward Voltage at 3.0 A	V_F	1.1						V
Maximum DC Reverse Current @ $T_A=25^\circ C$ @ $T_A=125^\circ C$	I_R	5 100						μA
Typical Junction Capacitance (Note1)	C_J	40						pF
Operating and Storage Temperature Range	T_j, T_{stg}	-55 ~ +150						°C

Note: 1. Measured at 1MHz and applied reverse voltage of 4 V D.C.

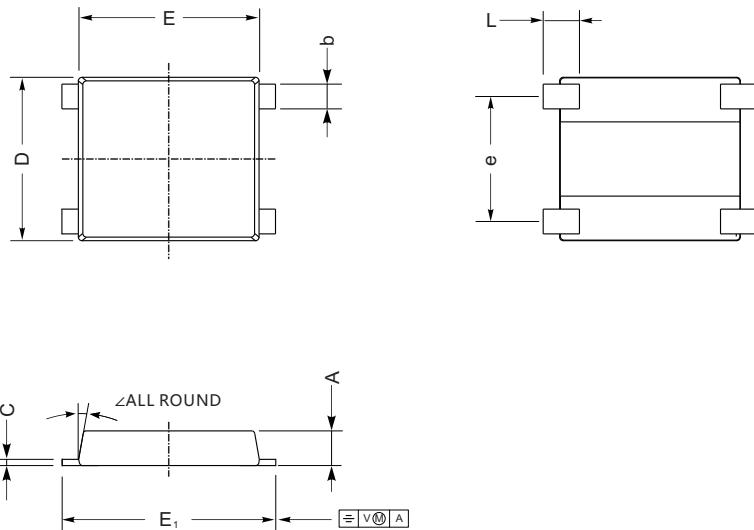
2. Mounted on glass epoxy PC board with 4×1.5"×1.5" (3.81×3.81 cm) copper pad.



PACKAGE OUTLINE

Plastic surface mounted package; 4 leads

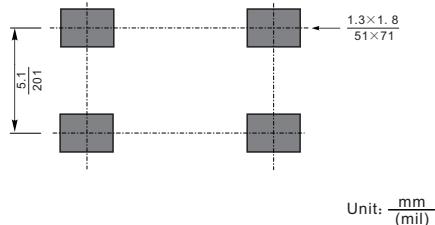
UMSB



UMSB mechanical data

UNIT		A	C	D	E	E ₁	L	e	b	∠
mm	max	1.5	0.29	7.0	7.6	8.9	1.6	5.3	1.15	10°
	min	1.3	0.17	6.2	7.1	8.4	1.0	4.9	0.95	
mil	max	59	12	276	299	350	55	209	45	10°
	min	51	7	244	280	331	31.5	193	37	

The recommended mounting pad size



Marking

Type number	Marking code
MSB30B	MB30B
MSB30D	MB30D
MSB30G	MB30G
MSB30J	MB30J
MSB30K	MB30K
MSB30M	MB30M